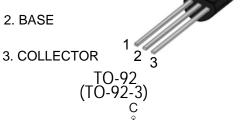


Features

Complementary NPN Type available (2N2907A)

1. EMITTER

2. BASE



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
2N2222A	TO-92(TO-92-3)	2N2222A	1000

Maxmim Ratings (Ta=25 unless otherwise noted)

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Base Voltage	75	V
V _{CEO}	Collector-Emitter Voltage	40	V
V _{EBO}	Emitter-Base Voltage	6	V
Ic	Collector Current -Continuous	0.6	А
P _D	Collector Power Dissipation	625	mW
R _{θ JA}	Thermal Resistance from Junction to Ambient	200	°C /W
T_J , T_{stg}	Operation Junction and Storage Temperature Range	-55~+150	$^{\circ}$

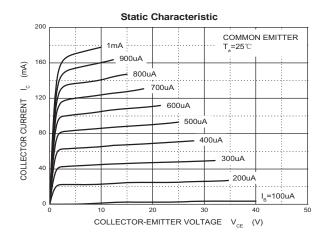
Electrcal Charcteristics (Ta=25 unless otherwise specified)

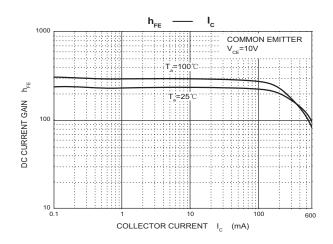
Parameter	Symbol	Test conditions	Min	Max	Unit
Collector-base breakdown voltage	V _{(BR)CBO}	I _C = 10uA , I _E =0	75		V
Collector-emitter breakdown voltage	V _{(BR)CEO}	I _C = 10mA , I _B =0	40		V
Emitter-base breakdown voltage	V _{(BR)EBO}	I _E = 10uA, I _C =0	6		V
Collector cut-off current	I _{CBO}	V _{CB} = 60V, I _E =0		10	nA
Collector cut-off current	I _{CEX}	V _{CE} = 60V,V _{EB(Off)} =3V		10	nA
Emitter cut-off current	I _{EBO}	V _{EB} = 3 V, I _C =0		100	nA
	h _{FE(1)}	V _{CE} =10V,I _C = 150mA		300	
DC current gain	h _{FE(2)}	V _{CE} =10V,I _C = 0.1mA	40		
	h _{FE(3)} *	V _{CE} =10V, I _C = 500mA	42		
Collector-emitter saturation voltage	V _{CE(sat)(1)} *	I _C = 500mA, I _B =50mA		0.6	V
Conector-enlitter Saturation voltage	V _{CE(sat)(2)} *	I _C = 150mA, I _B =15mA		0.3	V
Base-emitter saturation voltage $V_{BE(sat)}^{*}$ I_{C} = 500mA, I_{B} = 50mA		I _C = 500mA, I _B = 50mA		1.2	V
Delay time	t _d	V _{CC} =30V, V _{EB(Off)} =-0.5V,		10	nS
Rise time	t _r	I _C =150mA,I _{B1} =15mA		25	nS
Storage time	t _S	- V _{CC} =30V,Ic=150mA,I _{B1} =I _{B2} =15mA		225	nS
Fall time	t _f			60	nS
Transition frequency	f⊤	V _{CE} =20V, I _C =20mA, f=100MHz 300			MHz

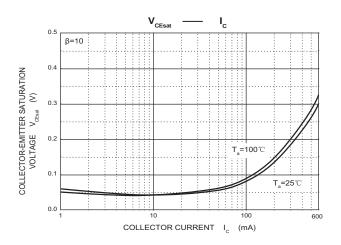
*pulse test

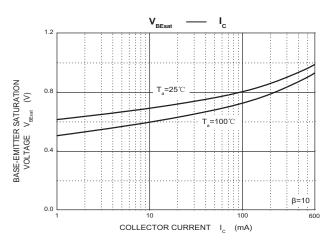


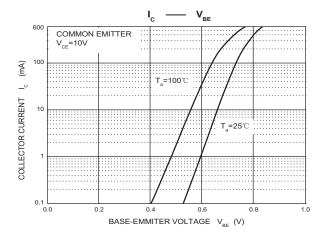
Typical Characteristics

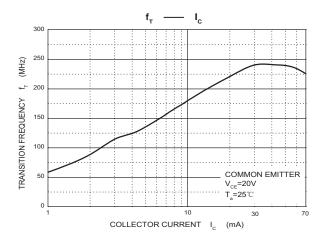


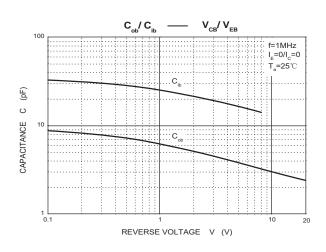


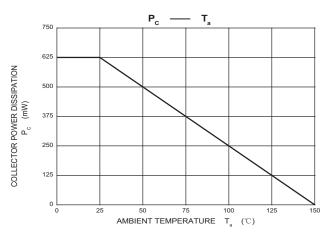




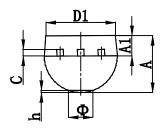


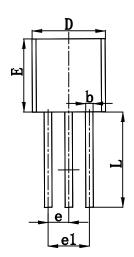






TO-92(TO-92-3) Package Outline Dimensions





Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	3.300	3.700	0.130	0.146	
A1	1.100	1.400	0.043	0.055	
b	0.380	0.550	0.015	0.022	
С	0.360	0.510	0.014	0.020	
D	4.300	4.700	0.169	0.185	
D1	3.430		0.135		
Е	4.300	4.700	0.169	0.185	
е	1.270 TYP		0.050 TYP		
e1	2.440	2.640	0.096	0.104	
L	14.100	14.500	0.555	0.571	
Φ		1.600		0.063	
h	0.000	0.380	0.000	0.015	



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